

MCP73861/2

Advanced Single or Dual Cell, Fully Integrated Li-Ion / Li-Polymer Charge Management Controllers

Features

- Linear Charge Management Controllers
 - Integrated Pass Transistor
 - Integrated Current Sense
 - Reverse-Blocking Protection
- High-Accuracy Preset Voltage Regulation: ± 0.5%
- Four Selectable Voltage Regulation Options:
 - 4.1V, 4.2V MCP73861
 - 8.2V, 8.4V MCP73862
- Programmable Charge Current: 1.2A Maximum
- · Programmable Safety Charge Timers
- · Preconditioning of Deeply Depleted Cells
- · Automatic End-of-Charge Control
- · Optional Continuous Cell Temperature Monitoring
- Charge Status Output for Direct LED Drive
- · Fault Output for Direct LED Drive
- · Automatic Power-Down
- Thermal Regulation
- Temperature Range: -40°C to 85°C
- Packaging: 16-Pin, 4 x 4 QFN

16-Pin SOIC (MCP73861 only)

Applications

- · Lithium-Ion/Lithium-Polymer Battery Chargers
- Personal Data Assistants (PDAs)
- Cellular Telephones
- · Hand-Held Instruments
- Cradle Chargers
- Digital Cameras
- MP3 Players

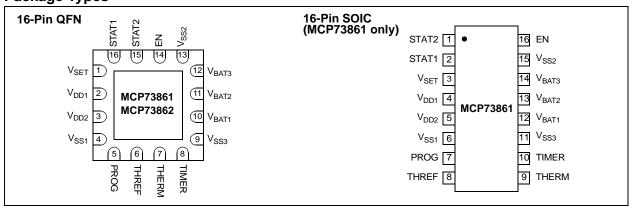
Description

The MCP7386X family of devices are highly advanced linear charge management controllers for use in space-limited, cost-sensitive applications. The MCP73861 and MCP73862 combine high-accuracy, constant voltage and current regulation, cell preconditioning, cell temperature monitoring, advanced safety timers, automatic charge termination, internal current sensing, reverse-blocking protection and charge status and fault indication in a space-saving 16-pin, 4 x 4 QFN package. The MCP73861 is also offered in a 16-pin SOIC package. The MCP7386X provides a complete, fully-functional, stand-alone charge management solution with a minimum number of external components.

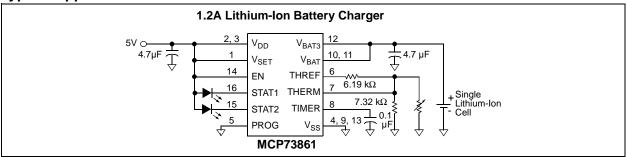
The MCP73861 is targeted at applications utilizing single-cell Lithium-Ion or Lithium-Polymer battery packs, while the MCP73862 is targeted at dual series cell Lithium-Ion or Lithium-Polymer battery packs. The MCP73861 has two selectable voltage-regulation options available (4.1V and 4.2V), for use with either coke or graphite anodes and operates with an input voltage range of 4.5V to 12V. The MCP73862 has two selectable voltage-regulation options available (8.2V and 8.4V), for use with coke or graphite anodes, and operates with an input voltage range of 8.7V to 12V.

The MCP7386X family of devices are fully specified over the ambient temperature range of -40°C to +85°C.

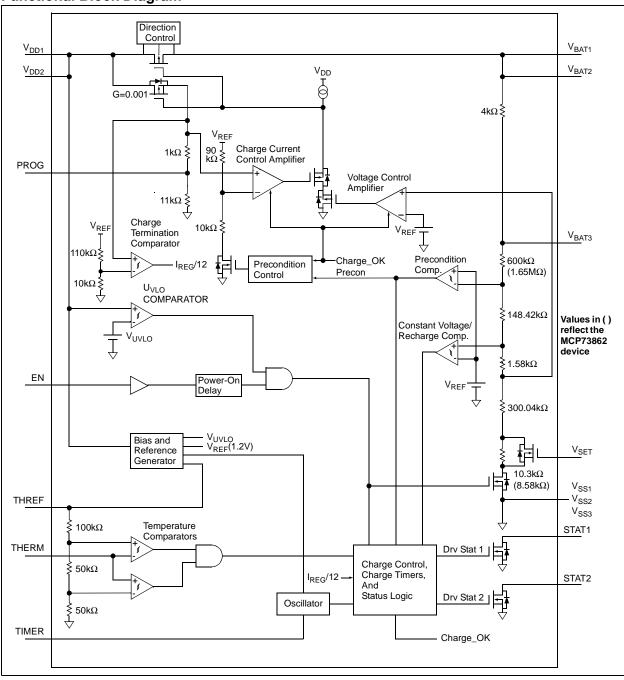
Package Types



Typical Application



Functional Block Diagram



1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings†

Machine Model (200 pF, No series resistance)300V

† Notice: Stresses above those listed under "Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

DC CHARACTERISTICS

| Electrical Specifications: $T_A = -40$ °C to 85°C. Typical | | | | | o) + 0.3V] | to 12V, |
|--|---|----------------|-------|-------|------------|--|
| Parameters | Sym | Min | Тур | Max | Units | Conditions |
| Supply Input | | | | | | |
| Supply Voltage | V_{DD} | 4.5 | _ | 12 | V | MCP73861 |
| | | 8.7 | _ | 12 | V | MCP73862 |
| Supply Current | I _{SS} | _ | 0.17 | 4 | μA | Disabled |
| | | _ | 0.53 | 4 | mA | Operating |
| UVLO Start Threshold | V _{START} | 4.25 | 4.5 | 4.65 | V | MCP73861 |
| | | 8.45 | 8.8 | 9.05 | V | MCP73862 |
| | | | | | | V _{DD} Low-to-High |
| UVLO Stop Threshold | V _{STOP} | 4.20 | 4.4 | 4.55 | V | MCP73861 |
| | | 8.40 | 8.7 | 8.95 | V | MCP73862 |
| | | | | | | V _{DD} High-to-Low |
| Voltage Regulation (Const | ant-Voltage N | Mode) | | | | |
| Regulated Output Voltage | V_{REG} | 4.079 | 4.1 | 4.121 | V | MCP73861, V _{SET} = V _{SS} |
| | | 4.179 | 4.2 | 4.221 | V | MCP73861, V _{SET} = V _{DD} |
| | | 8.159 | 8.2 | 8.241 | V | MCP73862, V _{SET} = V _{SS} |
| | | 8.358 | 8.4 | 8.442 | V | MCP73862, V _{SET} = V _{DD} |
| | | | | | | $V_{DD} = [V_{REG}(Typ) + 1V],$ $I_{OUT}=10 \text{ mA}$ $T_{A} = -5^{\circ}\text{C to } +55^{\circ}\text{C}$ |
| Line Regulation | $ (\Delta V_{BAT}/V_{BAT}) /V_{DD}$ | _ | 0.025 | 0.25 | %/V | $V_{DD} = [V_{REG}(Typ)+1V]$ to 12V $I_{OUT} = 10 \text{ mA}$ |
| Load Regulation | ΔV _{BAT} / V _{BAT} | _ | 0.01 | 0.25 | % | I_{OUT} = 10 mA to 150 mA V_{DD} = [V_{REG} (Typ)+1V] |
| Supply Ripple Attenuation | PSRR | _ | 60 | _ | dB | I _{OUT} = 10 mA, 10Hz to 1 kHz |
| | | _ | 42 | _ | dB | I _{OUT} = 10 mA, 10Hz to 10 kHz |
| | | | 28 | _ | dB | I _{OUT} = 10 mA, 10Hz to 1 MHz |
| Output Reverse-Leakage Current | I _{DIS} - CHARGE | _ | 0.23 | 1 | μA | $V_{DD} < V_{BAT} = V_{REG}(Typ)$ |
| Current Regulation (Fast 0 | Charge Const | tant-Current M | ode) | | | |
| Fast Charge Current | I _{REG} | 85 | 100 | 115 | mA | PROG = OPEN |
| Regulation | | 1020 | 1200 | 1380 | mA | PROG = V _{SS} |
| | | 425 | 500 | 575 | mA | PROG = $1.6 \text{ k}\Omega$ |
| | | | | | | $T_A = -5$ °C to +55°C |

MCP73861/2

DC CHARACTERISTICS (Continued)

| Electrical Specifications: $L_A = -40$ °C to 85°C. Typical v | Jnless otherw alues are at | vise indicated, all +25°C, V _{DD} = [V | limits apply for V 'REG (typ.) + 1.0\ | ' _{DD} = [V _{REG} (Typ) '] | + 0.3V] | to 12V, |
|--|--|--|--|---|---------|---|
| Parameters | Sym | Min | Тур | Max | Units | Conditions |
| Preconditioning Current R | egulation (T | rickle Charge C | onstant-Current | Mode) | | |
| Precondition Current | I _{PREG} | 5 | 10 | 15 | mA | PROG = OPEN |
| Regulation | | 60 | 120 | 180 | mA | PROG = V _{SS} |
| | | 25 | 50 | 75 | mA | PROG = 1.6 kΩ |
| | | | | | | T _A =-5°C to +55°C |
| Precondition Threshold | V_{PTH} | 2.70 | 2.80 | 2.90 | V | MCP73861, V _{SET} = V _{SS} |
| Voltage | | 2.75 | 2.85 | 2.95 | V | MCP73861, V _{SET} = V _{DD} |
| | | 5.40 | 5.60 | 5.80 | V | MCP73862, V _{SET} = V _{SS} |
| | | 5.50 | 5.70 | 5.90 | V | MCP73862, V _{SET} = V _{DD} |
| | | | | | | V _{BAT} Low-to-High |
| Charge Termination | | | | | ı | |
| Charge Termination | I _{TERM} | 6 | 8.5 | 11 | mA | PROG = OPEN |
| Current | | 70 | 90 | 120 | mA | PROG = V _{SS} |
| | | 32 | 41 | 50 | mA | PROG = $1.6 \text{ k}\Omega$ |
| | | | | | | T _A =-5°C to +55°C |
| Automatic Recharge | | | | | ı | |
| Recharge Threshold | V_{RTH} | V _{REG} - 300 mV | V _{REG} - 200 mV | V _{REG} -100 mV | V | MCP73861 |
| Voltage | KIII | _ | V _{REG} - 400 mV | _ | V | MCP73862 |
| | | KEG | REG | REG | | V _{BAT} High-to-Low |
| Thermistor Reference | | | | | | DAI 0 |
| Thermistor Reference | V_{THREF} | 2.475 | 2.55 | 2.625 | V | T _A = 25°C, |
| Output Voltage | ITINEI | - | | | | $V_{DD} = V_{REG}(typ.) + 1V,$ $I_{THREF} = 0 \text{ mA}$ |
| Thermistor Reference Source Current | I _{THREF} | 200 | _ | _ | μA | |
| Thermistor Reference Line Regulation | $ (\Delta V_{THREF}/V_{THREF}) /V_{DD}$ | _ | 0.1 | 0.25 | %/V | $V_{DD} = [V_{REG}(Typ) + 1V] \text{ to } 12V$ |
| Thermistor Reference Load Regulation | ΔV _{THREF} / V _{THREF} | | 0.01 | 0.10 | % | I _{THREF} = 0 mA to 0.20 mA |
| Thermistor Comparator | | | | | | |
| Upper Trip Threshold | V_{T1} | 1.18 | 1.25 | 1.32 | V | |
| Upper Trip Point Hysteresis | V _{T1HYS} | | -50 | | mV | |
| Lower Trip Threshold | V _{T2} | 0.59 | 0.62 | 0.66 | V | |
| Lower Trip Point Hysteresis | V _{T2HYS} | _ | 80 | _ | mV | |
| Input Bias Current | I _{BIAS} | _ | _ | 2 | μА | |
| Status Indicator – STAT1, S | | | | - | | |
| Sink Current | I _{SINK} | 4 | 8 | 12 | mA | |
| Low Output Voltage | V _{OL} | _ | 200 | 400 | mV | I _{SINK} = 1 mA |
| Input Leakage Current | I _{LK} | _ | 0.01 | 1 | μА | I _{SINK} = 0 mA, V _{STAT1,2} = 12V |
| Enable Input | | | | | | · · · · · · · · · · · · · · · · · · · |
| Input High Voltage Level | V _{IH} | 1.4 | _ | _ | V | |
| Input Low Voltage Level | V _{IL} | _ | _ | 0.8 | V | |
| Input Leakage Current | I _{LK} | _ | 0.01 | 1 | μΑ | V _{ENABLE} = 12V |
| Thermal Shutdown | LIX | 1 | 1 | 1 | | 1 214.000 |
| Die Temperature | T _{SD} | _ | 155 | _ | °C | |
| Die Temperature | T _{SDHYS} | _ | 10 | _ | °C | |
| Hysteresis | 051110 | | | | | |

AC CHARACTERISTICS

| Electrical Specifications: U T _A = -40°C to 85°C. Typical v | nless otherwise | e indicate | d, all lim | its apply | for V _{DD} = | [V _{REG} (typ.) + 0.3V] to 12V, |
|---|---------------------|------------|------------|-----------|-----------------------|--|
| Parameters | Sym | Min | Typ | Max | Units | Conditions |
| UVLO Start Delay | t _{START} | _ | _ | 5 | ms | V _{DD} Low-to-High |
| Current Regulation | • | • | | | • | |
| Transition Time Out of Preconditioning | t _{DELAY} | _ | _ | 1 | ms | $V_{BAT} < V_{PTH}$ to $V_{BAT} > V_{PTH}$ |
| Current Rise Time Out of Preconditioning | t _{RISE} | _ | _ | 1 | ms | I _{OUT} Rising to 90% of I _{REG} |
| Fast Charge Safety Timer Period | t _{FAST} | 1.1 | 1.5 | 1.9 | Hours | C _{TIMER} = 0.1 μF |
| Preconditioning Current Re | gulation | • | | | | |
| Preconditioning Charge Safety Timer Period | t _{PRECON} | 45 | 60 | 75 | Minutes | C _{TIMER} = 0.1 μF |
| Charge Termination | | • | | | | |
| Elapsed Time Termination Period | t _{TERM} | 2.2 | 3 | 3.8 | Hours | C _{TIMER} = 0.1 μF |
| Status Indicators | • | | | | • | • |
| Status Output turn-off | t _{OFF} | _ | _ | 200 | μs | I _{SINK} = 1 mA to 0 mA |
| Status Output turn-on | t _{ON} | _ | _ | 200 | μs | I _{SINK} = 0 mA to 1 mA |

TEMPERATURE SPECIFICATIONS

| Electrical Specifications: Unless otherwing Typical values are at +25°C, V _{DD} = [V _{REG} | | | s apply for | or V _{DD} = [\ | REG (typ.) |) + 0.3V] to 12V. |
|---|----------------|-----|-------------|-------------------------|------------|---|
| Parameters | Sym | Min | Тур | Max | Units | Conditions |
| Temperature Ranges | | | | | | |
| Specified Temperature Range | T _A | -40 | _ | +85 | °C | |
| Operating Temperature Range | TJ | -40 | _ | +125 | °C | |
| Storage Temperature Range | T _A | -65 | _ | +150 | °C | |
| Thermal Package Resistances | | | | | | |
| Thermal Resistance, 16-lead, 4 mm x 4 mm QFN | θ_{JA} | _ | 37 | _ | °C/W | 4-Layer JC51-7 Standard Board, Natural Convection |
| Thermal Resistance, 16-lead SOIC | θ_{JA} | _ | 74 | _ | °C/W | 4-Layer JC51-7 Standard Board, Natural Convection |

2.0 TYPICAL PERFORMANCE CURVES

Note: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.

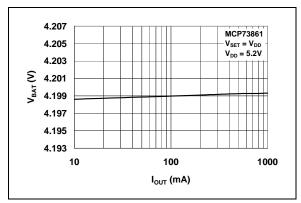


FIGURE 2-1: Battery Regulation Voltage (V_{BAT}) vs. Charge Current (I_{OUT}) .

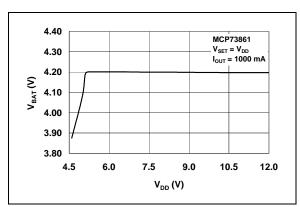


FIGURE 2-2: Battery Regulation Voltage (V_{BAT}) vs. Supply Voltage (V_{DD}) .

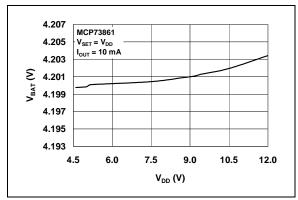


FIGURE 2-3: Battery Regulation Voltage (V_{BAT}) vs. Supply Voltage (V_{DD}) .

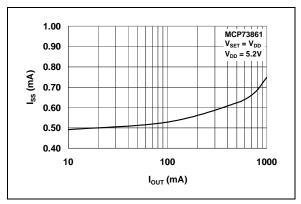


FIGURE 2-4: Supply Current (I_{SS}) vs. Charge Current (I_{OUT}).

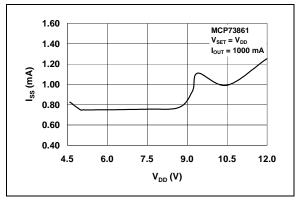


FIGURE 2-5: Supply Current (I_{SS}) vs. Supply Voltage (V_{DD}).

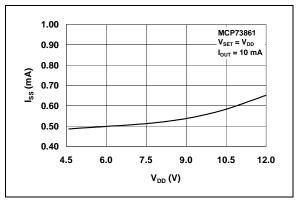


FIGURE 2-6: Supply Current (I_{SS}) vs. Supply Voltage (V_{DD}).

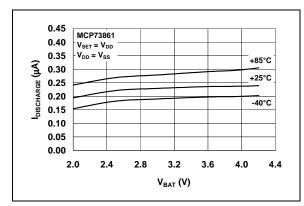


FIGURE 2-7: Output Leakage Current $(I_{DISCHARGE})$ vs. Battery Voltage (V_{BAT}) .

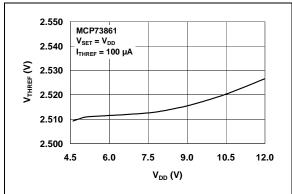


FIGURE 2-8: Thermistor Reference Voltage (V_{THREF}) vs. Supply Voltage (V_{DD}).

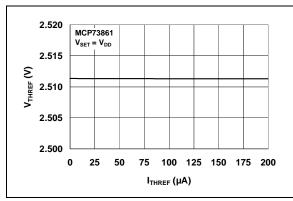


FIGURE 2-9: Thermistor Reference Voltage (V_{THREF}) vs. Thermistor Bias Current (I_{THREF}).

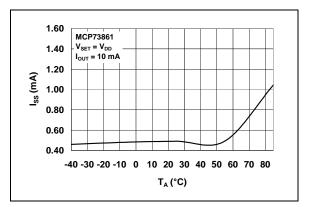


FIGURE 2-10: Supply Current (I_{SS}) vs. Ambient Temperature (T_A).

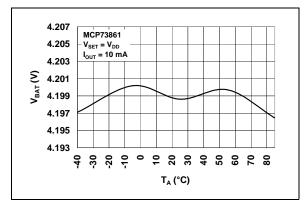


FIGURE 2-11: Battery Regulation Voltage (V_{BAT}) vs. Ambient Temperature (T_A) .

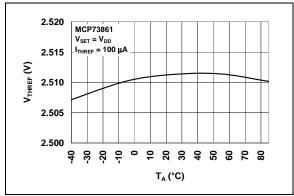


FIGURE 2-12: Thermistor Reference Voltage (V_{THREF}) vs. Ambient Temperature (T_A).

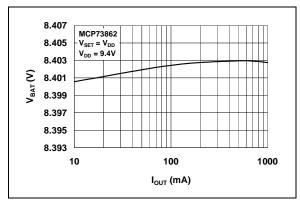


FIGURE 2-13: Battery Regulation Voltage (V_{BAT}) vs. Charge Current (I_{OUT}) .

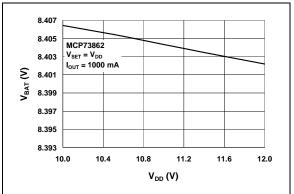


FIGURE 2-14: Battery Regulation Voltage (V_{BAT}) vs. Supply Voltage (V_{DD}) .

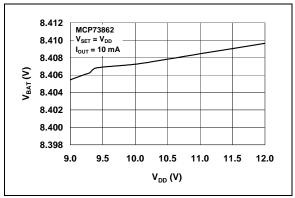


FIGURE 2-15: Battery Regulation Voltage (V_{BAT}) vs. Supply Voltage (V_{DD}) .

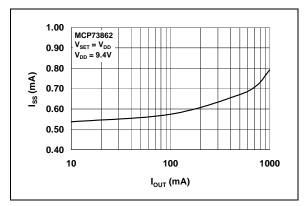


FIGURE 2-16: Supply Current (I_{SS}) vs. Charge Current (I_{OUT}).

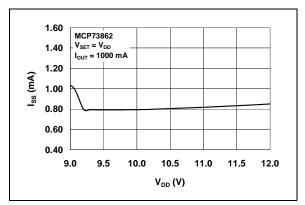


FIGURE 2-17: Supply Current (I_{SS}) vs. Supply Voltage (V_{DD}).

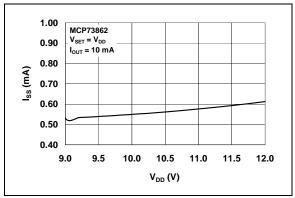


FIGURE 2-18: Supply Current (I_{SS}) vs. Supply Voltage (V_{DD}).

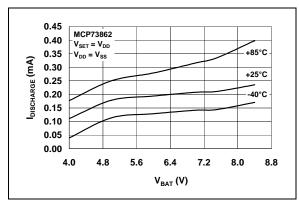


FIGURE 2-19: Output Leakage Current $(I_{DISCHARGE})$ vs. Battery Voltage (V_{BAT}) .

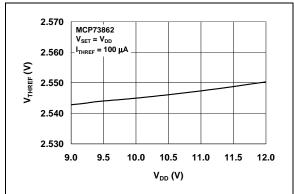


FIGURE 2-20: Thermistor Reference Voltage (V_{THREF}) vs. Supply Voltage (V_{DD}).

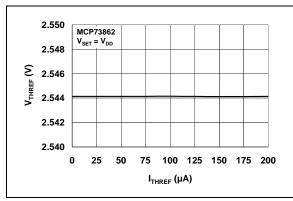


FIGURE 2-21: Thermistor Reference Voltage (V_{THREF}) vs. Thermistor Bias Current (I_{THREF}).

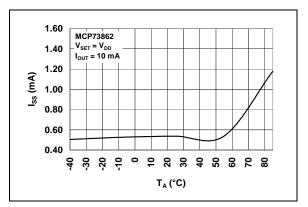


FIGURE 2-22: Supply Current (I_{SS}) vs. Ambient Temperature (I_A).

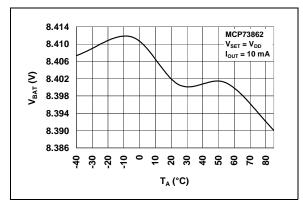


FIGURE 2-23: Battery Regulation Voltage (V_{BAT}) vs. Ambient Temperature (T_A) .

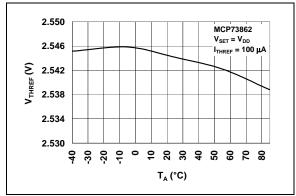


FIGURE 2-24: Thermistor Reference Voltage (V_{THREF}) vs. Ambient Temperature (T_A).

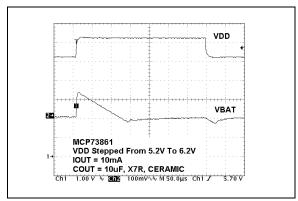
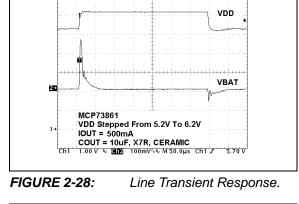


FIGURE 2-25: Line Transient Response.



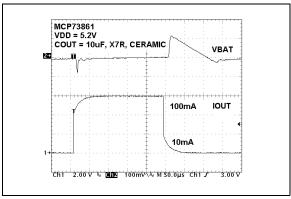


FIGURE 2-26: Load Transient Response.

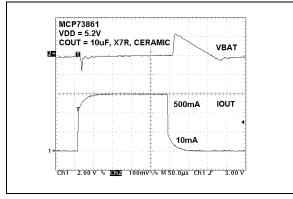


FIGURE 2-29: Load Transient Response.

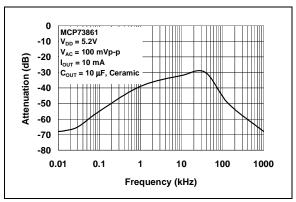


FIGURE 2-27: Power Supply Ripple Rejection.

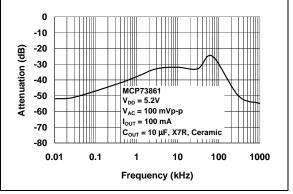


FIGURE 2-30: Power Supply Ripple Rejection.

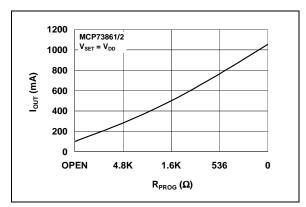


FIGURE 2-31: Charge Current (I_{OUT}) vs. Programming Resistor (R_{PROG}) .

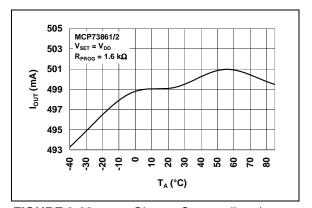


FIGURE 2-32: Charge Current (I_{OUT}) vs. Ambient Temperature (T_A).

3.0 PIN DESCRIPTION

The descriptions of the pins are listed in Table 3-1.

TABLE 3-1: PIN FUNCTION TABLES

| Pin | No. | 0 | F | | | | |
|-----|------|-------------------|---------------------------------|--|--|--|--|
| QFN | SOIC | Symbol | Function | | | | |
| 1 | 3 | V _{SET} | Voltage Regulation Selection | | | | |
| 2 | 4 | V _{DD1} | Battery Management Input Supply | | | | |
| 3 | 5 | V_{DD2} | Battery Management Input Supply | | | | |
| 4 | 6 | V _{SS1} | Battery Management 0V Reference | | | | |
| 5 | 7 | PROG | Current Regulation Set | | | | |
| 6 | 8 | THREF | Cell Temperature Sensor Bias | | | | |
| 7 | 9 | THERM | Cell Temperature Sensor Input | | | | |
| 8 | 10 | TIMER | Timer Set | | | | |
| 9 | 11 | V _{SS3} | Battery Management 0V Reference | | | | |
| 10 | 12 | V _{BAT1} | Battery Charge Control Output | | | | |
| 11 | 13 | V _{BAT2} | Battery Charge Control Output | | | | |
| 12 | 14 | V _{BAT3} | Battery Voltage Sense | | | | |
| 13 | 15 | V _{SS2} | Battery Management 0V Reference | | | | |
| 14 | 16 | EN | Logic Enable | | | | |
| 15 | 1 | STAT2 | Fault Status Output | | | | |
| 16 | 2 | STAT1 | Charge Status Output | | | | |

3.1 Voltage Regulation Selection (V_{SET})

MCP73861: Connect to V_{SS} for 4.1V regulation voltage, connect to V_{DD} for 4.2V regulation voltage. **MCP73862**: Connect to V_{SS} for 8.2V regulation voltage, connect to V_{DD} for 8.4V regulation voltage.

3.2 Battery Management Input Supply (V_{DD2}, V_{DD1})

A supply voltage of [V_{REG}(Typ) + 0.3V] to 12V is recommended. Bypass to V_{SS} with a minimum of 4.7 μ F.

3.3 Battery Management 0V Reference (V_{SS1}, V_{SS2}, V_{SS3})

Connect to negative terminal of battery and input supply.

3.4 Current Regulation Set (PROG)

Preconditioning, fast and termination currents are scaled by placing a resistor from PROG to $V_{\rm SS}$.

3.5 Cell Temperature Sensor Bias (THREF)

Voltage reference to bias external thermistor for continuous cell temperature monitoring and pregualification.

3.6 Cell Temperature Sensor Input (THERM)

Input for an external thermistor for continuous cell-temperature monitoring and prequalification. Connect to THREF/3 to disable temperature sensing.

3.7 Timer Set

All safety timers are scaled by $C_{\mbox{\scriptsize TIMER}}/0.1~\mu\mbox{\scriptsize F}.$

3.8 Battery Charge Control Output (V_{BAT1}, V_{BAT2})

Connect to positive terminal of battery. Drain terminal of internal P-channel MOSFET pass transistor. Bypass to V_{SS} with a minimum of 4.7 μF to ensure loop stability when the battery is disconnected.

3.9 Battery Voltage Sense (V_{BAT3})

Voltage sense input. Connect to positive terminal of battery. A precision internal resistor divider regulates the final voltage on this pin to $V_{\mbox{\scriptsize REG}}.$

3.10 Logic Enable (EN)

Input to force charge termination, initiate charge, clear faults or disable automatic recharge.

3.11 Fault Status Output (STAT2)

Current-limited, open-drain drive for direct connection to a LED for charge status indication. Alternatively, a pull-up resistor can be applied for interfacing to a host microcontroller.

3.12 Charge Status Output (STAT1)

Current-limited, open-drain drive for direct connection to a LED for charge status indication. Alternatively, a pull-up resistor can be applied for interfacing to a host microcontroller.

4.0 DEVICE OVERVIEW

The MCP7386X family of devices are highly advanced linear charge management controllers. Refer to the functional block diagram. Figure 4-2 depicts the operational flow algorithm from charge initiation to completion and automatic recharge.

4.1 Charge Qualification and Preconditioning

Upon insertion of a battery or application of an external supply, the MCP7386X family of devices automatically performs a series of safety checks to qualify the charge. The input source voltage must be above the Undervoltage Lockout (UVLO) threshold, the enable pin must be above the logic-high level and the cell temperature must be within the upper and lower thresholds. The qualification parameters are continuously monitored. Deviation beyond the limits automatically suspends or terminates the charge cycle. The input voltage must deviate below the undervoltage lockout stop threshold for at least one clock period to be considered valid.

Once the qualification parameters have been met, the MCP7386X initiates a charge cycle. The charge status output is pulled low throughout the charge cycle (see Table 5-1 for charge status outputs). If the battery voltage is below the preconditioning threshold (V_{PTH}) the MCP7386X preconditions the battery with a trickle-charge. The preconditioning current is set to approximately 10% of the fast charge regulation current. The preconditioning trickle-charge safely replenishes deeply depleted cells and minimizes heat dissipation during the initial charge cycle. If the battery voltage has not exceeded the preconditioning threshold before the preconditioning timer has expired, a fault is indicated and the charge cycle is terminated.

4.2 Constant Current Regulation – Fast Charge

Preconditioning ends, and fast charging begins, when the battery voltage exceeds the preconditioning threshold. Fast charge regulates to a constant current (I_{REG}), which is set via an external resistor connected to the PROG pin. Fast charge continues until the battery voltage reaches the regulation voltage (V_{REG}), or the fast charge timer expires; in which case, a fault is indicated and the charge cycle is terminated.

4.3 Constant Voltage Regulation

When the battery voltage reaches the regulation voltage (V_{REG}), constant voltage regulation begins. The MCP7386X monitors the battery voltage at the V_{BAT} pin. This input is tied directly to the positive terminal of the battery. The MCP7386X selects the voltage regulation value based on the state of the V_{SET} . With V_{SET} tied to V_{SS} , the MCP73861 and MCP73862 regulate to

4.1V and 8.2V, respectively. With V_{SET} tied to V_{DD} , the MCP73861 and MCP73862 regulate to 4.2V and 8.4V, respectively.

4.4 Charge Cycle Completion and Automatic Re-Charge

The MCP7386X monitors the charging current during the Constant-voltage regulation mode. The charge cycle is considered complete when the charge current has diminished below approximately 8% of the regulation current (I_{REG}) or the elapsed timer has expired.

The MCP7386X automatically begins a new charge cycle when the battery voltage falls below the recharge threshold ($V_{\rm RTH}$), assuming all the qualification parameters are met.

4.5 Thermal Regulation

The MCP7386X family limits the charge current based on the die temperature. Thermal regulation optimizes the charge cycle time while maintaining device reliability. If thermal regulation is entered, the timer is automatically slowed down to ensure that a charge cycle will not terminate prematurely. Figure 4-1 depicts the thermal regulation profile.

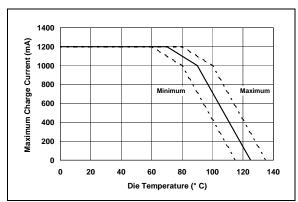


FIGURE 4-1: Typical Maximum Charge Current vs. Die Temperature.

4.6 Thermal Shutdown

The MCP7386X family suspends charge if the die temperature exceeds 155°C. Charging will resume when the die temperature has cooled by approximately 10°C. The thermal shutdown is a secondary safety feature in the event that there is a failure within the thermal regulation circuitry.

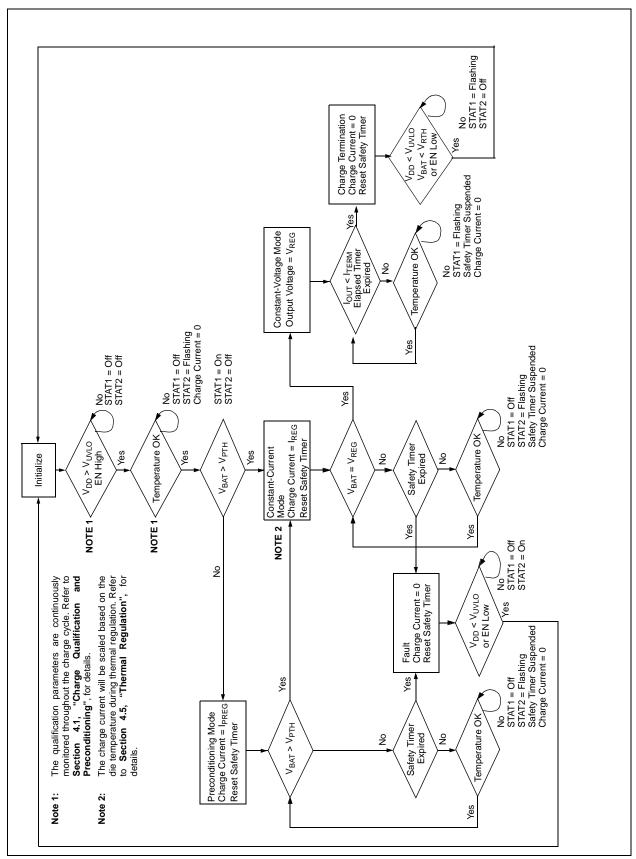


FIGURE 4-2: Operational Flow Algorithm.

5.0 DETAILED DESCRIPTION

5.1 Analog Circuitry

5.1.1 BATTERY MANAGEMENT INPUT SUPPLY (V_{DD1}, V_{DD2})

The V_{DD} input is the input supply to the MCP7386X. The MCP7386X automatically enters a Power-down mode if the voltage on the V_{DD} input falls below the undervoltage lockout voltage (V_{STOP}). This feature prevents draining the battery pack when the V_{DD} supply is not present.

5.1.2 PROG INPUT

Fast charge current regulation can be scaled by placing a programming resistor (R_{PROG}) from the PROG input to V_{SS} . Connecting the PROG input to V_{SS} allows for a maximum fast charge current of 1.2A, typically. The minimum fast charge current is 100 mA, set by letting the PROG input float. The following formula calculates the value for R_{PROG} :

$$R_{PROG} = \frac{13.2 - 11 \times I_{REG}}{12 \times I_{REG} - 1.2}$$

where:

I_{REG} is the desired fast charge current in amps

 R_{PROG} is in $k\Omega$.

The preconditioning trickle-charge current and the charge termination current are scaled to approximately 10% and 8% of I_{RFG} respectively.

5.1.3 CELL TEMPERATURE SENSOR BIAS (THREF)

A 2.5V voltage reference is provided to bias an external thermistor for continuous cell temperature monitoring and prequalification. A ratio metric window comparison is performed at threshold levels of $V_{THREF}/2$ and $V_{THREF}/4$.

5.1.4 CELL TEMPERATURE SENSOR INPUT (THERM)

The MCP73861 and MCP73862 continuously monitor temperature by comparing the voltage between the THERM input and V_{SS} with the upper and lower temperature thresholds. A negative or positive temperature coefficient, NTC or PTC thermistor and an external voltage-divider typically develop this voltage. The temperature sensing circuit has its own reference to which it performs a ratio metric comparison. Therefore, it is immune to fluctuations in the supply input (V_{DD}) . The temperature-sensing circuit is removed from the system when V_{DD} is not applied, eliminating additional discharge of the battery pack.

Figure 6-1 depicts a typical application circuit with connection of the THERM input. The resistor values of $R_{T1}\,$ and $\,R_{T2}\,$ are calculated with the following equations.

For NTC thermistors:

$$R_{TI} = \frac{2 \times R_{COLD} \times R_{HOT}}{R_{COLD} - R_{HOT}}$$

$$R_{T2} = \frac{2 \times R_{COLD} \times R_{HOT}}{R_{COLD} - 3 \times R_{HOT}}$$

For PTC thermistors:

$$R_{T1} = \frac{2 \times R_{COLD} \times R_{HOT}}{R_{HOT} - R_{COLD}}$$

$$R_{T2} = \frac{2 \times R_{COLD} \times R_{HOT}}{R_{HOT} - 3 \times R_{COLD}}$$

Where:

 R_{COLD} and R_{HOT} are the thermistor resistance values at the temperature window of interest.

Applying a voltage equal to $V_{\mbox{THREF}}/3$ to the THERM input disables temperature monitoring.

5.1.5 TIMER SET INPUT (TIMER)

The TIMER input programs the period of the safety timers by placing a timing capacitor (C_{TIMER}) between the TIMER input pin and V_{SS} . Three safety timers are programmed via the timing capacitor.

The preconditioning safety timer period:

$$t_{PRECON} = \frac{C_{TIMER}}{0.1 \mu F} \times 1.0 Hours$$

The fast charge safety timer period:

$$t_{FAST} = \frac{C_{TIMER}}{0.1 \, \text{uF}} \times 1.5 Hours$$

And, the elapsed time termination period:

$$t_{TERM} = \frac{C_{TIMER}}{0.1 \mu F} \times 3.0 Hours$$

The preconditioning timer starts after qualification and resets when the charge cycle transitions to the fast charge, Constant-current mode. The fast charge timer and the elapsed timer start after the MCP7386X transitions from preconditioning. The fast charge timer resets when the charge cycle transitions to the Constant-voltage mode. The elapsed timer will expire and terminate the charge if the sensed current does not diminish below the termination threshold.

During thermal regulation, the timer is slowed down proportional to the charge current.

5.1.6 BATTERY VOLTAGE SENSE (V_{BAT3})

The MCP7386X monitors the battery voltage at the V_{BAT3} pin. This input is tied directly to the positive terminal of the battery pack.

5.1.7 BATTERY CHARGE CONTROL OUTPUT (V_{BAT1}, V_{BAT2})

The battery charge control output is the drain terminal of an internal P-channel MOSFET. The MCP7386X provides constant current and voltage regulation to the battery pack by controlling this MOSFET in the linear region. The battery charge control output should be connected to the positive terminal of the battery pack.

5.2 Digital Circuitry

5.2.1 CHARGE STATUS OUTPUTS (STAT1,STAT2)

Two status outputs provide information on the state of charge. The current-limited, open-drain outputs can be used to illuminate external LEDs. Optionally, a pull-up resistor can be used on the output for communication with a host microcontroller. Table 5-1 summarizes the state of the status outputs during a charge cycle.

TABLE 5-1: STATUS OUTPUTS

| CHARGE CYCLE STAT1 | STAT1 | STAT2 |
|-------------------------------------|---------------------------------|---------------------------------|
| Qualification | Off | Off |
| Preconditioning | On | Off |
| Constant- Current Fast Charge | On | Off |
| Constant- Voltage | On | Off |
| Charge Complete | Flashing (1 Hz, 50% duty cycle) | Off |
| Fault | Off | On |
| THERM Invalid | Off | Flashing (1 Hz, 50% duty cycle) |
| Disabled – Sleep mode | Off | Off |
| Input Voltage Disconnected | Off | Off |

Note: Off state: Open-drain is high-impedance;

On state: Open-drain can sink current,

typically 7 mA;

Flashing: Toggles between off state and

on state.

The flashing rate (1 Hz) is based off a timer capacitor (C_{TIMER}) of 0.1 μ F. The rate will vary based on the value of the timer capacitor.

During a fault condition, the STAT1 status output will be off and the STAT2 status output will be on. To recover from a fault condition, the input voltage must be removed and then reapplied, or the enable input (EN) must be de-asserted to a logic-low, then asserted to a logic-high.

When the voltage on the THERM input is outside the preset window, the charge cycle will not start, or will be suspended. The charge cycle is not terminated and recovery is automatic. The charge cycle will resume or start once the THERM input is valid and all other qualification parameters are met. During an invalid THERM condition, the STAT1 status output will be off and the STAT2 status output will flash.

5.2.2 V_{SFT} INPUT

The V_{SET} input selects the regulated output voltage of the MCP7386X. With V_{SET} tied to V_{SS} , the MCP73861 and MCP73862 regulate to 4.1V and 8.2V, respectively. With V_{SET} tied to V_{DD} , the MCP73861 and MCP73862 regulate to 4.2V and 8.4V, respectively.

5.2.3 LOGIC ENABLE (EN)

The logic enable input pin (EN) can be used to terminate a charge at any time during the charge cycle, as well as to initiate a charge cycle or initiate a recharge cycle.

Applying a logic-high input signal to the EN pin, or tying it to the input source, enables the device. Applying a logic-low input signal disables the device and terminates a charge cycle. When disabled, the device's supply current is reduced to 0.17 µA, typically.

6.0 APPLICATIONS

The MCP7386X is designed to operate in conjunction with a host microcontroller or in stand-alone applications. The MCP7386X provides the preferred charge algorithm for Lithium-lon and Lithium-Polymer cells,

constant current followed by constant voltage. Figure 6-1 depicts a typical stand-alone application circuit and Figures 6-2 and 6-3 depict the accompanying charge profile.

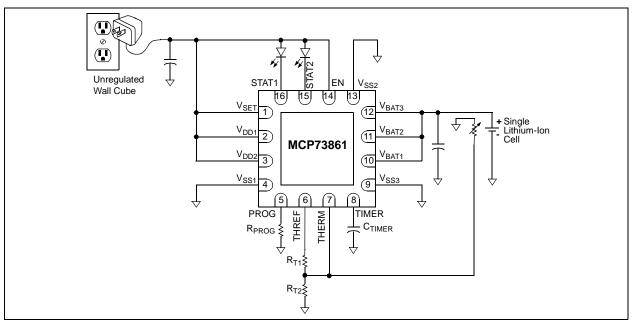


FIGURE 6-1: Typical Application Circuit.

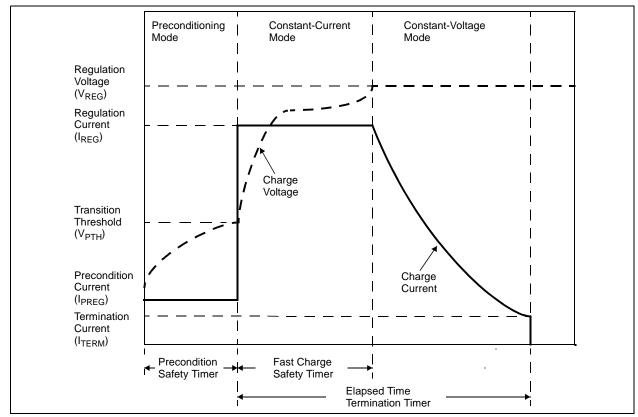


FIGURE 6-2: Typical Charge Profile.

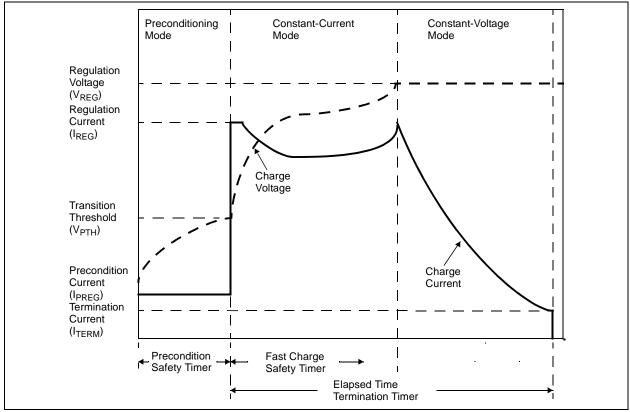


FIGURE 6-3: Typical Charge Profile in Thermal Regulation.

6.1 Application Circuit Design

Due to the low efficiency of linear charging, the most important factors are thermal design and cost, which are a direct function of the input voltage, output current and thermal impedance between the battery charger and the ambient cooling air. The worst-case situation is when the device has transitioned from the Preconditioning mode to the Constant-current mode. In this situation, the battery charger has to dissipate the maximum power. A trade-off must be made between the charge current, cost and thermal requirements of the charger.

6.1.1 COMPONENT SELECTION

Selection of the external components in Figure 6-1 is crucial to the integrity and reliability of the charging system. The following discussion is intended as a guide for the component selection process.

6.1.1.1 Current Programming Resistor (R_{PROG})

The preferred fast charge current for Lithium-Ion cells is at the 1C rate, with an absolute maximum current at the 2C rate. For example, a 500 mAh battery pack has a preferred fast charge current of 500 mA. Charging at this rate provides the shortest charge cycle times without degradation to the battery pack performance or life.

1200 mA is the maximum charge current obtainable from the MCP7386X. For this situation, the PROG input should be connected directly to $\rm V_{SS}$.

6.1.1.2 Thermal Considerations

The worst-case power dissipation in the battery charger occurs when the input voltage is at the maximum and the device has transitioned from the Preconditioning mode to the Constant-current mode. In this case, the power dissipation is:

$$Power Dissipation = (V_{DDMAX} - V_{PTHMIN}) \times I_{REGMAX}$$
 Where:

 V_{DDMAX} is the maximum input voltage I_{REGMAX} is the maximum fast charge current V_{PTHMIN} is the minimum transition threshold voltage.

Power dissipation with a 5V, ±10% input voltage source is:

 $PowerDissipation = (5.5V - 2.7V) \times 575mA = 1.61W$

With the battery charger mounted on a 1 in² pad of 1 oz. copper, the junction temperature rise is 60°C, approximately. This would allow for a maximum operating ambient temperature of 50°C before thermal regulation is entered.

6.1.1.3 External Capacitors

The MCP7386X is stable with or without a battery load. In order to maintain good AC stability in the Constant-voltage mode, a minimum capacitance of 4.7 μF is recommended to bypass the V_{BAT} pin to $V_{SS}.$ This capacitance provides compensation when there is no battery load. In addition, the battery and interconnections appear inductive at high frequencies. These elements are in the control feedback loop during Constant-voltage mode. Therefore, the bypass capacitance may be necessary to compensate for the inductive nature of the battery pack.

Virtually any good quality output filter capacitor can be used, independent of the capacitor's minimum Effective Series Resistance (ESR) value. The actual value of the capacitor and its associated ESR depends on the output load current. A 4.7 μ F ceramic, tantalum or aluminum electrolytic capacitor at the output is usually sufficient to ensure stability for up to a 1A output current.

6.1.1.4 Reverse-Blocking Protection

The MCP7386X provides protection from a faulted or shorted input, or from a reversed-polarity input source. Without the protection, a faulted or shorted input would discharge the battery pack through the body diode of the internal pass transistor.

6.1.1.5 Enable Interface

In the stand-alone configuration, the enable pin is generally tied to the input voltage. The MCP7386X automatically enters a low-power mode when voltage on the V_{DD} input falls below the undervoltage lockout voltage (V_{STOP}), reducing the battery drain current to 0.23 μA , typically.

6.1.1.6 Charge Status Interface

Two status outputs provide information on the state of charge. The current-limited, open-drain outputs can be used to illuminate external LEDs. Refer to Table 5-1 for a summary of the state of the status outputs during a charge cycle.

6.2 PCB Layout Issues

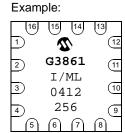
For optimum voltage regulation, place the battery pack as close as possible to the device's V_{BAT} and V_{SS} pins. It is recommended to minimize voltage drops along the high current-carrying PCB traces.

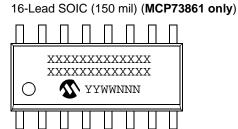
If the PCB layout is used as a heatsink, adding many vias in the heatsink pad can help conduct more heat to the backplane of the PCB, thus reducing the maximum junction temperature.

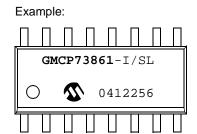
7.0 PACKAGING INFORMATION

7.1 Package Marking Information







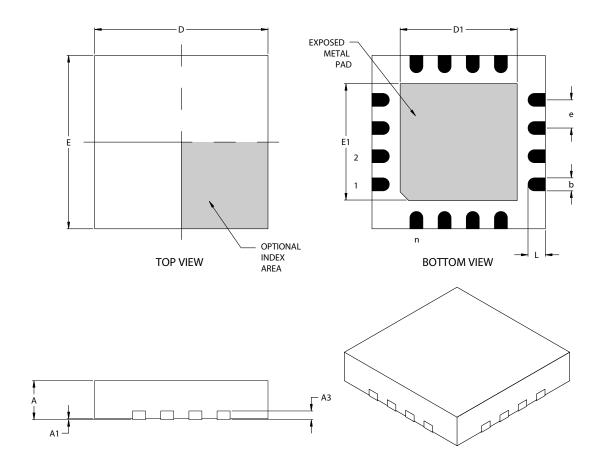


Legend: XX...X Customer specific information*
YY Year code (last 2 digits of calendar year)
WW Week code (week of January 1 is week '01')
NNN Alphanumeric traceability code

Note: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line thus limiting the number of available characters for customer specific information.

* Standard OTP marking consists of Microchip part number, year code, week code, and traceability code.

16-Lead Plastic Quad Flat No Lead Package (ML) 4x4x0.9 mm Body (QFN) – Saw Singulated



| | Units | | INCHES | | М | ILLIMETERS* | | |
|--------------------|-------|------|----------|------|----------|-------------|------|--|
| Dimension Limi | ts | MIN | NOM | MAX | MIN | NOM | MAX | |
| Number of Pins | n | | 16 | | 16 | | | |
| Pitch | e | | .026 BSC | | | 0.65 BSC | | |
| Overall Height | Α | .031 | .035 | .039 | 0.80 | 0.90 | 1.00 | |
| Standoff | A1 | .000 | .001 | .002 | 0.00 | 0.02 | 0.05 | |
| Contact Thickness | A3 | | .008 REF | | 0.20 REF | | | |
| Overall Width | E | .152 | .157 | .163 | 3.85 | 4.00 | 4.15 | |
| Exposed Pad Width | E2 | .100 | .106 | .110 | 2.55 | 2.70 | 2.80 | |
| Overall Length | D | .152 | .157 | .163 | 3.85 | 4.00 | 4.15 | |
| Exposed Pad Length | D2 | .100 | .106 | .110 | 2.55 | 2.70 | 2.80 | |
| Contact Width | b | .010 | .012 | .014 | 0.25 | 0.30 | 0.35 | |
| Contact Length | L | .012 | .016 | .020 | 0.30 | 0.40 | 0.50 | |

*Controlling Parameter

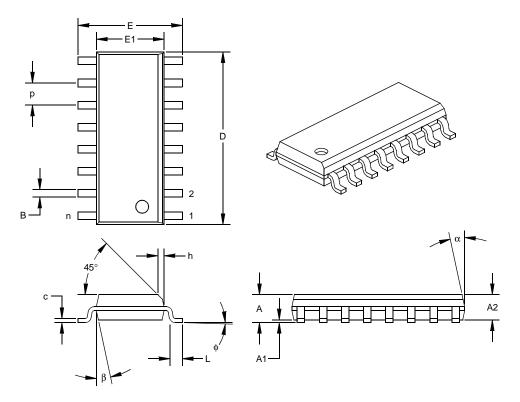
Notes:

JEDEC equivalent: MO-220

Drawing No. C04-127

Revised 04-24-05

16-Lead Plastic Small Outline (SL) - Narrow 150 mil Body (SOIC)



| Units | | | INCHES* | | N | 11LLIMETERS | 3 |
|--------------------------|----------|------|---------|------|------|-------------|-------|
| Dimension | n Limits | MIN | NOM | MAX | MIN | NOM | MAX |
| Number of Pins | n | | 16 | | | 16 | |
| Pitch | р | | .050 | | | 1.27 | |
| Overall Height | Α | .053 | .061 | .069 | 1.35 | 1.55 | 1.75 |
| Molded Package Thickness | A2 | .052 | .057 | .061 | 1.32 | 1.44 | 1.55 |
| Standoff § | A1 | .004 | .007 | .010 | 0.10 | 0.18 | 0.25 |
| Overall Width | Е | .228 | .237 | .244 | 5.79 | 6.02 | 6.20 |
| Molded Package Width | E1 | .150 | .154 | .157 | 3.81 | 3.90 | 3.99 |
| Overall Length | D | .386 | .390 | .394 | 9.80 | 9.91 | 10.01 |
| Chamfer Distance | h | .010 | .015 | .020 | 0.25 | 0.38 | 0.51 |
| Foot Length | L | .016 | .033 | .050 | 0.41 | 0.84 | 1.27 |
| Foot Angle | ф | 0 | 4 | 8 | 0 | 4 | 8 |
| Lead Thickness | С | .008 | .009 | .010 | 0.20 | 0.23 | 0.25 |
| Lead Width | В | .013 | .017 | .020 | 0.33 | 0.42 | 0.51 |
| Mold Draft Angle Top | α | 0 | 12 | 15 | 0 | 12 | 15 |
| Mold Draft Angle Bottom | β | 0 | 12 | 15 | 0 | 12 | 15 |

Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed

.010" (0.254mm) per side.
JEDEC Equivalent: MS-012

Drawing No. C04-108

^{*} Controlling Parameter § Significant Characteristic

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

| PART NO. | x xx | Examples: |
|-------------------|--|---|
| | perature Package ange | a) MCP73861T-I/MLG: Tape and Reel, Single-Cell Controller b) MCP73861-I/MLG: Single-Cell Controller |
| Device | MCP73861: Single-cell charge controller with temperature monitor MCP73861T: Single-cell charge controller with temperature monitor, Tape and Reel MCP73862: Dual series cells charge controller with temperature monitor MCP73862T: Dual series cells charge controller with temperature monitor, Tape and Reel | a) MCP73862T-I/MLG: Tape and Reel, |
| Temperature Range | I = -40°C to +85°C (Industrial) | |
| Packages | ML = Plastic Quad Flat No Lead, 4x4 mm Body (QFN), 16-lead SL = Plastic Small Outline, 150 mm Body (SOIC), 16-lead | |
| Lead Finish | G = Matte Tin (Pure Sn) | |

Sales and Support

Data Sheets

Products supported by a preliminary Data Sheet may have an errata sheet describing minor operational differences and recommended workarounds. To determine if an errata sheet exists for a particular device, please contact one of the following:

- 1. Your local Microchip sales office
- 2. The Microchip Worldwide Site (www.microchip.com)

Please specify which device, revision of silicon and Data Sheet (include Literature #) you are using.

Customer Notification System

Register on our web site (www.microchip.com) to receive the most current information on our products.

MCP73861/2

NOTES:

Note the following details of the code protection feature on Microchip devices:

- Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the
 intended manner and under normal conditions.
- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our knowledge, require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data Sheets. Most likely, the person doing so is engaged in theft of intellectual property.
- · Microchip is willing to work with the customer who is concerned about the integrity of their code.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of their code. Code protection does not
 mean that we are guaranteeing the product as "unbreakable."

Code protection is constantly evolving. We at Microchip are committed to continuously improving the code protection features of our products. Attempts to break Microchip's code protection feature may be a violation of the Digital Millennium Copyright Act. If such acts allow unauthorized access to your software or other copyrighted work, you may have a right to sue for relief under that Act.

Information contained in this publication regarding device applications and the like is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications. MICROCHIP MAKES NO REPRESENTATIONS OR WAR-RANTIES OF ANY KIND WHETHER EXPRESS OR IMPLIED, WRITTEN OR ORAL, STATUTORY OR OTHERWISE, RELATED TO THE INFORMATION, INCLUDING BUT NOT LIMITED TO ITS CONDITION, QUALITY, PERFORMANCE, MERCHANTABILITY OR FITNESS FOR PURPOSE. Microchip disclaims all liability arising from this information and its use. Use of Microchip's products as critical components in life support systems is not authorized except with express written approval by Microchip. No licenses are conveyed, implicitly or otherwise, under any Microchip intellectual property rights.

Trademarks

The Microchip name and logo, the Microchip logo, Accuron, dsPIC, KEELOQ, microID, MPLAB, PIC, PICmicro, PICSTART, PRO MATE, PowerSmart, rfPIC, and SmartShunt are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

AmpLab, FilterLab, MXDEV, MXLAB, PICMASTER, SEEVAL, SmartSensor and The Embedded Control Solutions Company are registered trademarks of Microchip Technology Incorporated in the U.S.A.

Analog-for-the-Digital Age, Application Maestro, dsPICDEM, dsPICDEM.net, dsPICworks, ECAN, ECONOMONITOR, FanSense, FlexROM, fuzzyLAB, In-Circuit Serial Programming, ICSP, ICEPIC, Migratable Memory, MPASM, MPLIB, MPLINK, MPSIM, PICkit, PICDEM, PICDEM.net, PICLAB, PICtail, PowerCal, PowerInfo, PowerMate, PowerTool, rfLAB, rfPICDEM, Select Mode, Smart Serial, SmartTel and Total Endurance are trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

 $\ensuremath{\mathsf{SQTP}}$ is a service mark of Microchip Technology Incorporated in the U.S.A.

All other trademarks mentioned herein are property of their respective companies.

© 2005, Microchip Technology Incorporated, Printed in the U.S.A., All Rights Reserved.

Printed on recycled paper.

QUALITY MANAGEMENT SYSTEM
CERTIFIED BY DNV

ISO/TS 16949:2002

Microchip received ISO/TS-16949:2002 quality system certification for its worldwide headquarters, design and wafer fabrication facilities in Chandler and Tempe, Arizona and Mountain View, California in October 2003. The Company's quality system processes and procedures are for its PICmicro® 8-bit MCUs, KEELoo® code hopping devices, Serial EEPROMs, microperipherals, nonvolatile memory and analog products. In addition, Microchip's quality system for the design and manufacture of development systems is ISO 9001:2000 certified.



WORLDWIDE SALES AND SERVICE

AMERICAS

Corporate Office

2355 West Chandler Blvd. Chandler, AZ 85224-6199 Tel: 480-792-7200

Fax: 480-792-7200 Fax: 480-792-7277 Technical Support:

http://support.microchip.com

Web Address: www.microchip.com

Atlanta

Alpharetta, GA Tel: 770-640-0034 Fax: 770-640-0307

Boston

Westford, MA Tel: 978-692-3848 Fax: 978-692-3821

Chicago Itasca, IL

Tel: 630-285-0071 Fax: 630-285-0075

Dallas

Addison, TX Tel: 972-818-7423 Fax: 972-818-2924

Detroit

Farmington Hills, MI Tel: 248-538-2250 Fax: 248-538-2260

Kokomo

Kokomo, IN Tel: 765-864-8360 Fax: 765-864-8387

Los Angeles

Mission Viejo, CA Tel: 949-462-9523 Fax: 949-462-9608

San Jose

Mountain View, CA Tel: 650-215-1444 Fax: 650-961-0286

Toronto

Mississauga, Ontario,

Canada

Tel: 905-673-0699 Fax: 905-673-6509

ASIA/PACIFIC

Australia - Sydney

Tel: 61-2-9868-6733 Fax: 61-2-9868-6755

China - Beijing

Tel: 86-10-8528-2100 Fax: 86-10-8528-2104

China - Chengdu

Tel: 86-28-8676-6200 Fax: 86-28-8676-6599

China - Fuzhou

Tel: 86-591-8750-3506 Fax: 86-591-8750-3521

China - Hong Kong SAR

Tel: 852-2401-1200 Fax: 852-2401-3431

China - Shanghai Tel: 86-21-5407-5533

Fax: 86-21-5407-5066 **China - Shenyang**

Tel: 86-24-2334-2829 Fax: 86-24-2334-2393

China - Shenzhen

Tel: 86-755-8203-2660 Fax: 86-755-8203-1760

China - Shunde

Tel: 86-757-2839-5507 Fax: 86-757-2839-5571

China - Qingdao

Tel: 86-532-502-7355 Fax: 86-532-502-7205

ASIA/PACIFIC

India - Bangalore

Tel: 91-80-2229-0061 Fax: 91-80-2229-0062

India - New Delhi

Tel: 91-11-5160-8631 Fax: 91-11-5160-8632

Japan - Kanagawa

Tel: 81-45-471- 6166 Fax: 81-45-471-6122

Korea - Seoul

Tel: 82-2-554-7200 Fax: 82-2-558-5932 or

82-2-558-5934

Singapore Tel: 65-6334-8870 Fax: 65-6334-8850

- · · · · ·

Taiwan - Kaohsiung Tel: 886-7-536-4818 Fax: 886-7-536-4803

Taiwan - Taipei

Tel: 886-2-2500-6610 Fax: 886-2-2508-0102

Taiwan - Hsinchu

Tel: 886-3-572-9526 Fax: 886-3-572-6459

EUROPE

Austria - Weis

Tel: 43-7242-2244-399 Fax: 43-7242-2244-393 **Denmark - Ballerup**

Tel: 45-4450-2828 Fax: 45-4485-2829

France - Massy

Tel: 33-1-69-53-63-20 Fax: 33-1-69-30-90-79

Germany - Ismaning

Tel: 49-89-627-144-0 Fax: 49-89-627-144-44

Italy - Milan

Tel: 39-0331-742611 Fax: 39-0331-466781

Netherlands - Drunen Tel: 31-416-690399

Fax: 31-416-690340 England - Berkshire

Tel: 44-118-921-5869 Fax: 44-118-921-5820 This datasheet has been download from:

www.datasheetcatalog.com

Datasheets for electronics components.